BT137S series E

GENERAL DESCRIPTION

Passivated, sensitive gate triacs in a plastic envelope, suitable for surface mounting, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V _{drm} I _{t(rms)} I _{tsm}	BT137S- Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current	600E 600 8 65	800E 800 8 65	V A A

SYMBOL

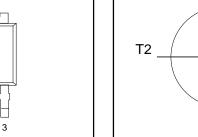
PINNING - SOT428

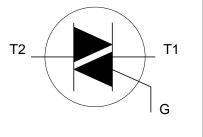
PIN	DESCRIPTION
1	MT1
2	MT2
3	gate
tab	MT2

2

1

PIN CONFIGURATION





LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	AX.	UNIT
V _{drm}	Repetitive peak off-state voltages		-	-600 600 ¹	-800 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{mb} \le 102$ °C full sine wave; $T_j = 25$ °C prior to surge	-	8	3	A
		t = 20 ms	-		5	A
l ² t	l ² t for fusing	t = 16.7 ms	-	7		A A ² s
dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after	t = 10 ms $I_{TM} = 12 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	2	.1	AS
	triggering	T2+ G+ T2+ G-	-		0 0	A/μs
		T2+ G- T2- G-	-		0	A/μs A/μs
		T2- G+	-		0	A/μs
I _{GM}	Peak gate current		-	2	2	Á
I _{GM} V _{GM}	Peak gate voltage		-	Į	2 5	V
P _{GM}	Peak gate power	aver env 20 me naried	-			W
$\begin{array}{c} P_{G(AV)}^{Siw} \\ T_{stg}^{stg} \\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	-40 -	15	.5 50 25	° ℃ W

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 $A/\mu s$.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb} R _{th j-a}		full cycle half cycle pcb (FR4) mounted; footprint as in Fig.14	-	- - 75	2.0 2.4 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

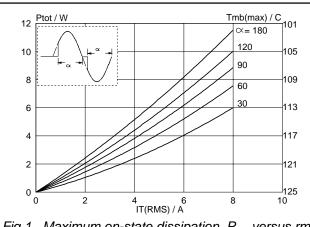
SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$					
01			T2+ G+	-	2.5	10	mA
			T2+ G-	-	4.0	10	mA
			T2- G-	-	5.0	10	mA
			T2- G+	-	11	25	mA
IL.	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$					
-			T2+ G+	-	3.0	25	mA
			T2+ G-	-	14	35	mA
			T2- G-	-	3.0	25	mA
			T2- G+	-	4.0	35	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$		-	2.5	20	mA
I _H V _T V _{GT}	On-state voltage	$I_{T} = 10 \text{ A}$		-	1.3	1.65	V
V _{GT}	Gate trigger voltage	$\dot{V}_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$		-	0.7	1.5	V
		$V_{\rm D} = 400 \text{ V}; I_{\rm T} = 0.1 \text{ A}; T_{\rm i} = 125$	5°C	0.25	0.4	-	V
I _D	Off-state leakage current	$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125$ $V_D = V_{DRM(max)}; T_j = 125 ^{\circ}\text{C}$		-	0.1	0.5	mA

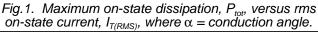
DYNAMIC CHARACTERISTICS

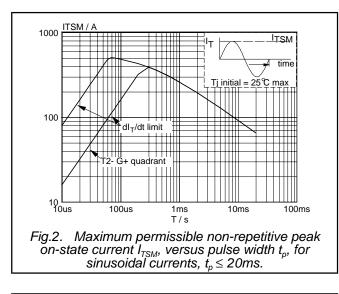
 $T_i = 25$ °C unless otherwise stated

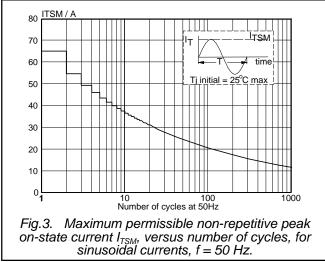
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Critical rate of rise of	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$	-	50	-	V/µs
t _{gt}	off-state voltage Gate controlled turn-on time	exponential waveform; gate open circuit $I_{TM} = 12 \text{ A}$; $V_D = V_{DRM(max)}$; $I_G = 0.1 \text{ A}$; $dI_G/dt = 5 \text{ A}/\mu s$	-	2	-	μs

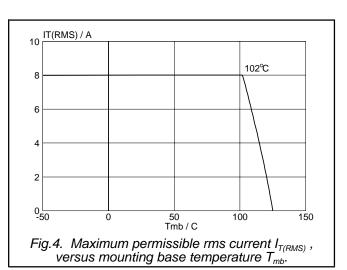
BT137S series E











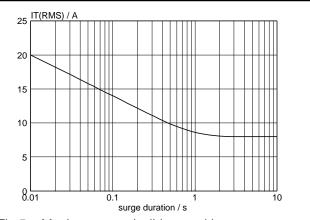
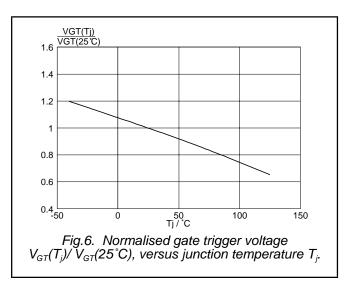


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{mb} \le 102$ °C.



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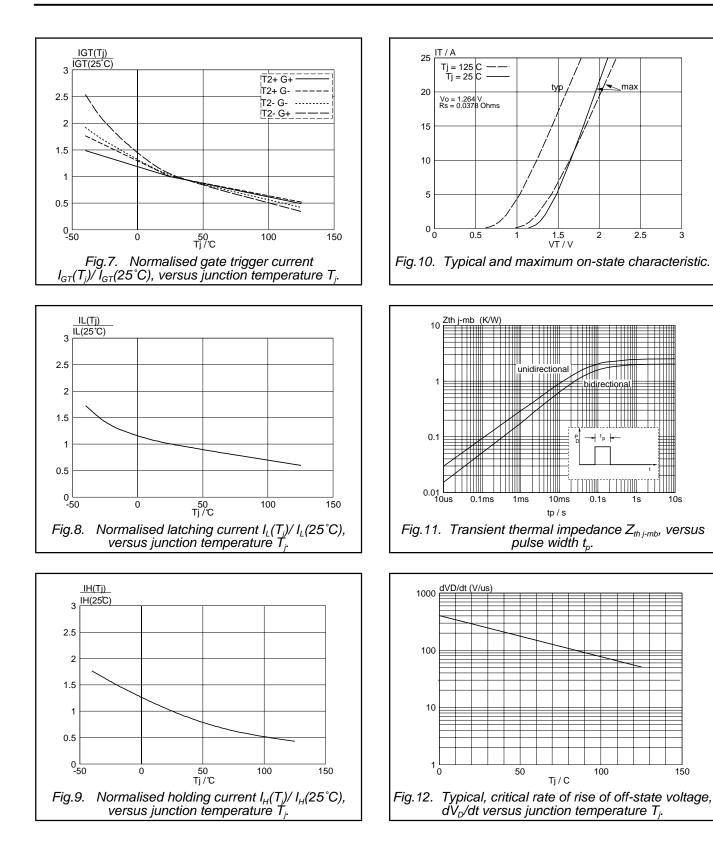
max

2.5

1s

10s

3

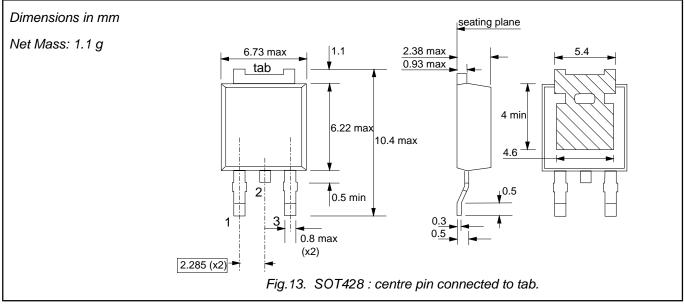


150

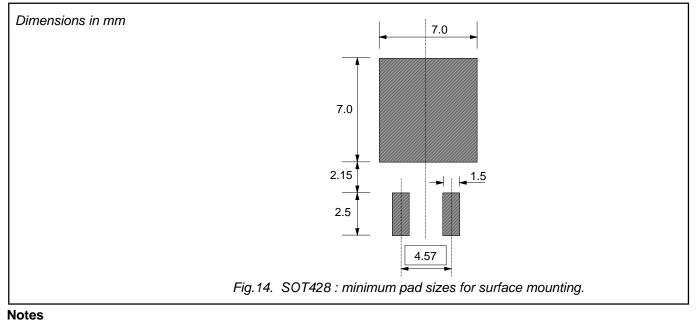
Product specification

BT137S series E

MECHANICAL DATA



MOUNTING INSTRUCTIONS



1. Plastic meets UL94 V0 at 1/8".

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DEFINITIONS

DATA SHEET STATUS					
DATA SHEET STATUS ²	PRODUCT STATUS ³	DEFINITIONS			
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice			
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in ordere to improve the design and supply the best possible product			
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A			
Limiting values	•	·			

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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